PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yasuhiro KAWAGUCHI	03/11/2011
Yoshiyuki KOSAKA	03/11/2011
Kenichi MATSUMURA	03/11/2011

RECEIVING PARTY DATA

Name:	SEKISUI CHEMICAL CO., LTD.	
Street Address:	4-4, Nishitemma 2-chome, Kita-ku, Osaka-shi,	
City:	Osaka	
State/Country:	JAPAN	
Postal Code:	530-8565	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13056203

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ATTORNEY DOCKET NUMBER:	2010_1719A
NAME OF SUBMITTER:	Donna King

Total Attachments: 2

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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned Yasuhiro KAWAGUCHI Insert Name(s) Yoshiyuki KOSAKA οŧ Inventor(s) Kenichi MATSUMURA the undersigned hereby sell(s) and assign(s) to Insert Name(s) SEKISUI CHEMICAL CO., LTD. Assignee(s) of 4-4, Nishitemma 2-chome, Kita-ku, Osaka-shi, Osaka 530-8565, Japan Address (hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as Title of Invention MASTERBATCH FOR FOAM MOLDING AND MOLDED FOAM Date of for which an application for patent in the United States has been executed by the undersigned Signing of Application The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient. The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference. The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements. The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

RECORDED: 03/14/2011

NO. 2026.4.P. 59100115 SK 749 US

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East, Washington, D.C. 20005-1503, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordal of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	MAR. 1 1.2011	Yasuhiro KAWAGUEHI	
	WAD 1 1 2014	Yasuhiro KAWAGUCHI	
Date	MAR. 1 1. 2011	Yoshiyuki Kosaka	
		Yoshiyuki KO\$AKA	
Date	MAR. 1 1. 2011	Kenichi Matsumura	
•	•	Kenichi MATSUMURA	
	The above application	n may be more particularly identified as follows:	
U.S. 4	Application Serial No.:	NEW Filing Date:	
Applicant Reference Number: <u>SK749US</u> Attorney Docket No.: <u>2010_1719A</u>			

PATENT

REEL: 025945 FRAME: 0387